## **Supporting Information**

## Lead-free perovskite Rb<sub>2</sub>Sn<sub>1-x</sub>Te<sub>x</sub>Cl<sub>6</sub> with bright luminescence for optical thermometry and tunable white light emitting diodes

Shunfa Gong <sup>a</sup>, Ruirui Wu <sup>a</sup>, Qiuju Han <sup>b</sup>, Degui Kong <sup>a, \*</sup>, Wenzhi Wu <sup>a, \*\*</sup>

<sup>a</sup> School of Electronic Engineering, Heilongjiang University Harbin, Heilongjiang, 150080, China

<sup>b</sup> School of Arts and Sciences, Northeast Agricultural University Harbin, Heilongjiang, 150030,

China

\* Corresponding author's E-mail: kongdegui@hlju.edu.cn and wuwenzhi@hlju.edu.cn



Figure S1 The optical band gap is calculated by the Tauc-plot formula based on the absorption spectra. the band gap obtained of (a)  $Rb_2SnCl_6$  MCs, (b)  $Rb_2Sn_{0.95}Te_{0.05}Cl_6$  MCs, (c)  $Rb_2Sn_{0.9}Te_{0.1}Cl_6$  MCs, (d)  $Rb_2Sn_{0.8}Te_{0.2}Cl_6$  MCs, (e)  $Rb_2Sn_{0.5}Te_{0.5}Cl_6$  MCs (f)  $Rb_2TeCl_6$  MCs.



Figure S2 PLQY with x values changing



Figure S3 The XPS spectra of (a) Te 3d. (b) Sn 3d. (c) Cl 2p. (d) Rb 3d





Figure S4 PL spectra, temperature dependence of emission peak wavelength and The normalized PL pseudocolor map of (a-c) Rb<sub>2</sub>SnCl<sub>6</sub>, (d-f) Rb<sub>2</sub>Sn<sub>0.95</sub>Te<sub>0.05</sub>Cl<sub>6</sub>, (g-i) Rb<sub>2</sub>Sn<sub>0.5</sub>Te<sub>0.5</sub>Cl<sub>6</sub> (j-l) Rb<sub>2</sub>Sn<sub>0.2</sub>Te<sub>0.8</sub>Cl<sub>6</sub> (m-o) Rb<sub>2</sub>Sn<sub>0.1</sub>Te<sub>0.9</sub>Cl<sub>6</sub> (p-r) Rb<sub>2</sub>TeCl<sub>6</sub> MCs at 80-380 K.





Figure S5 PL spectra of (a)Rb<sub>2</sub>SnCl<sub>6</sub> (b)Rb<sub>2</sub>Sn<sub>0.1</sub>Te<sub>0.9</sub>Cl<sub>6</sub> (c)Rb<sub>2</sub>Sn<sub>0.2</sub>Te<sub>0.8</sub>Cl<sub>6</sub>
(d)Rb<sub>2</sub>Sn<sub>0.5</sub>Te<sub>0.5</sub>Cl<sub>6</sub> (e)Rb<sub>2</sub>TeCl<sub>6</sub> MCs at 405 nm CW laser at different pump fluence under 80 K, and the insets are the linear fitting between PL intensity and pump fluence



Figure S6 (a) The LED chip without coating Rb<sub>2</sub>Sn<sub>0.95</sub>Te<sub>0.05</sub>Cl<sub>6</sub>MCs (b) The way prepares the mixture of the light-transmitting encapsulating silica gel A and the light-shading encapsulating silica gel B and Rb<sub>2</sub>Sn<sub>0.95</sub>Te<sub>0.05</sub>Cl<sub>6</sub>. (c) The LED chip with coating Rb<sub>2</sub>Sn<sub>0.95</sub>Te<sub>0.05</sub>Cl<sub>6</sub> MCs.